



查询"ADG1419BRMZ-REEL7"供应商

2.1 Ω On Resistance, ±15 V/+12 V/±5 V iCMOS SPDT Switch

ADG1419

FEATURES

- 2.1 Ω on resistance
- 0.5 Ω maximum on resistance flatness at 25°C
- Up to 390 mA continuous current
- Fully specified at +12 V, ±15 V, ±5 V
- No V_L supply required
- 3 V logic-compatible inputs
- Rail-to-rail operation
- 8-lead MSOP and 8-lead 3 mm × 2 mm LFCSP packages

APPLICATIONS

- Automatic test equipment
- Data acquisition systems
- Battery-powered systems
- Relay replacements
- Sample-and-hold systems
- Audio signal routing
- Video signal routing
- Communication systems

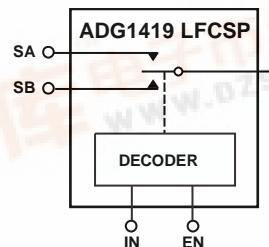
GENERAL DESCRIPTION

The ADG1419 is a monolithic iCMOS® device containing a single-pole/double-throw (SPDT) switch. An EN input on the LFCSP package is used to enable or disable the device. When disabled, all channels are switched off.

The iCMOS (industrial CMOS) modular manufacturing process combines high voltage, complementary metal-oxide semiconductor (CMOS) and bipolar technologies. It enables the development of a wide range of high performance analog ICs capable of 33 V operation in a footprint that no other generation of high voltage parts has achieved. Unlike analog ICs using conventional CMOS processes, iCMOS components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduced package size.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. The iCMOS construction ensures ultralow power dissipation, making the part ideally suited for portable and battery-powered instruments.

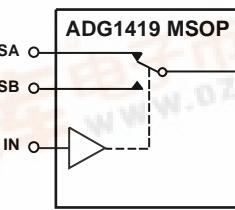
FUNCTIONAL BLOCK DIAGRAM



SWITCHES SHOWN FOR A LOGIC 0 INPUT.

08485-001

Figure 1. 8-Lead LFCSP Functional Block Diagram



SWITCHES SHOWN FOR A LOGIC 0 INPUT.

08485-002

Figure 2. 8-Lead MSOP Functional Block Diagram

Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked. The ADG1419 exhibits break-before-make switching action for use in multiplexer applications.

PRODUCT HIGHLIGHTS

- 2.4 Ω maximum on resistance at 25°C.
- Minimum distortion.
- 3 V logic-compatible digital inputs: $V_{INH} = 2.0$ V, $V_{INL} = 0.8$ V.
- No V_L logic power supply required.
- 8-lead MSOP and 8-lead, 3 mm × 2 mm LFCSP packages.

Rev. 0

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REVISION HISTORY

10/09—Revision 0: Initial Version

SPECIFICATIONS**±15 V DUAL SUPPLY**

$V_{DD} = +15 \text{ V} \pm 10\%$, $V_{SS} = -15 \text{ V} \pm 10\%$, $GND = 0 \text{ V}$, unless otherwise noted.

Table 1.

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$V_{DD} \text{ to } V_{SS}$	V	
On Resistance, R_{ON}	2.1			$\Omega \text{ typ}$	$V_S = \pm 10 \text{ V}, I_S = -10 \text{ mA}$; see Figure 22
	2.4	2.8	3.2	$\Omega \text{ max}$	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}$
On Resistance Match Between Channels, ΔR_{ON}	0.05			$\Omega \text{ typ}$	$V_S = \pm 10 \text{ V}, I_S = -10 \text{ mA}$
	0.2	0.25	0.3	$\Omega \text{ max}$	
On Resistance Flatness, $R_{FLAT(ON)}$	0.4			$\Omega \text{ typ}$	$V_S = \pm 10 \text{ V}, I_S = -10 \text{ mA}$
	0.5	0.6	0.65	$\Omega \text{ max}$	
LEAKAGE CURRENTS					
Source Off Leakage, I_S (Off)	± 0.1			$nA \text{ typ}$	$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
	± 0.5	± 2	± 75	$nA \text{ max}$	$V_S = \pm 10 \text{ V}, V_S = \pm 10 \text{ V}$; see Figure 23
Drain Off Leakage, I_D (Off)	± 0.2			$nA \text{ typ}$	$V_S = \pm 10 \text{ V}, V_S = \pm 10 \text{ V}$; see Figure 23
	± 0.6	± 3	± 100	$nA \text{ max}$	
Channel On Leakage, I_D, I_S (On)	± 0.2			$nA \text{ typ}$	$V_S = V_D = \pm 10 \text{ V}$; see Figure 24
	± 1	± 3	± 100	$nA \text{ max}$	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.005		± 0.1	$\mu A \text{ typ}$	$V_{IN} = V_{GND} \text{ or } V_{DD}$
Digital Input Capacitance, C_{IN}	4			$\mu F \text{ typ}$	
DYNAMIC CHARACTERISTICS ¹					
Transition Time, $t_{TRANSITION}$	130			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
	155	190	220	ns max	$V_S = +10 \text{ V}$; see Figure 25
t_{ON} (EN)	85			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
	110	125	140	ns max	$V_S = 10 \text{ V}$; see Figure 27
t_{OFF} (EN)	115			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
	140	160	180	ns max	$V_S = 10 \text{ V}$; see Figure 27
Break-Before-Make Time Delay, t_D	15		8	ns min	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
Charge Injection	-16			pC typ	$V_{S1} = V_{S2} = 10 \text{ V}$; see Figure 26
Off Isolation	-64			dB typ	$V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$; see Figure 29
Channel-to-Channel Crosstalk	-64			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 30
Total Harmonic Distortion + Noise	0.016			% typ	$R_L = 10 \text{ k}\Omega, 5 \text{ V rms}, f = 20 \text{ Hz to } 20 \text{ kHz}$; see Figure 32
-3 dB Bandwidth	135			MHz typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}$; see Figure 31
Insertion Loss	0.16			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 31
C_S (Off)	19			pF typ	$f = 1 \text{ MHz}; V_S = 0 \text{ V}$
C_D (Off)	44			pF typ	$f = 1 \text{ MHz}; V_S = 0 \text{ V}$
C_D, C_S (On)	114			pF typ	$f = 1 \text{ MHz}; V_S = 0 \text{ V}$

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
POWER REQUIREMENTS					
I _{DD}	0.002		1.0	µA typ µA max	V _{DD} = +16.5 V, V _{SS} = -16.5 V Digital inputs = 0 V or V _{DD}
I _{DD} , 8-Lead MSOP	58		95	µA typ µA max	Digital inputs = 5 V
I _{DD} , 8-Lead LFCSP	120		190	µA typ µA max	Digital inputs = 5 V
I _{SS}	0.002		1.0	µA typ µA max	Digital inputs = 0 V, 5 V or V _{DD}
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	Ground = 0 V

¹ Guaranteed by design, not subject to production test.

+12 V SINGLE SUPPLY

V_{DD} = 12 V ± 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 2.

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range		0 V to V _{DD}		V	
On Resistance, R _{ON}	4			Ω typ Ω max	V _S = 0 V to 10 V, I _S = -10 mA; see Figure 22
On Resistance Match Between Channels, ΔR _{ON}	4.6	5.5	6.2	Ω typ Ω max	V _{DD} = +10.8 V, V _{SS} = 0 V
On Resistance Flatness, R _{FLAT (ON)}	0.08			Ω typ Ω max	V _S = 0 V to 10 V, I _S = -10 mA
	0.25	0.3	0.35	Ω typ Ω max	
	1.2			Ω typ	V _S = 0 V to 10 V, I _S = -10 mA
	1.5	1.75	1.9	Ω max	
LEAKAGE CURRENTS					
Source Off Leakage, I _S (Off)	±0.1			nA typ	V _{DD} = +13.2 V, V _{SS} = 0 V
	±0.5	±2	±75	nA max	V _S = 1 V/10 V, V _D = 10 V/1 V; see Figure 23
Drain Off Leakage, I _D (Off)	±0.2			nA typ	V _S = 1 V/10 V, V _D = 10 V/1 V; see Figure 23
Channel On Leakage, I _D , I _S (On)	±0.6	±3	±100	nA max	
	±0.2			nA typ	V _S = V _D = 1 V or 10 V; see Figure 24
	±1	±3	±100	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}		2.0		V min	
Input Low Voltage, V _{INL}		0.8		V max	
Input Current, I _{INL} or I _{INH}	0.005		±0.1	µA typ µA max	V _{IN} = V _{GND} or V _{DD}
Digital Input Capacitance, C _{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS ¹					
Transition Time, t _{TRANSITION}	200			ns typ	R _L = 300 Ω, C _L = 35 pF
t _{ON} (EN)	255	265	370	ns max	V _S = 8 V; see Figure 25
	145			ns typ	R _L = 300 Ω, C _L = 35 pF
t _{OFF} (EN)	190	220	245	ns max	V _S = 8 V; see Figure 27
	130			ns typ	R _L = 300 Ω, C _L = 35 pF
Break-Before-Make Time Delay, t _D	170	205	220	ns max	V _S = 8 V; see Figure 27
	55		33	ns typ	R _L = 300 Ω, C _L = 35 pF
Charge Injection	13			ps typ	V _{S1} = V _{S2} = 8 V; see Figure 26
Off Isolation	-60			dB typ	V _S = 6 V, R _S = 0 Ω, C _L = 1 nF; see Figure 28
					R _L = 50 Ω, C _L = 5 pF, f = 1 MHz; see Figure 29

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
Channel-to-Channel Crosstalk	-60			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 30
-3 dB Bandwidth	95			MHz typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}$; see Figure 31
Insertion Loss	0.3			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 31
C_S (Off)	32			pF typ	$f = 1 \text{ MHz}; V_S = 6 \text{ V}$
C_D (Off)	72			pF typ	$f = 1 \text{ MHz}; V_S = 6 \text{ V}$
C_D, C_S (On)	123			pF typ	$f = 1 \text{ MHz}; V_S = 6 \text{ V}$
POWER REQUIREMENTS					
I_{DD}	0.001		1.0	μA typ	$V_{DD} = 13.2 \text{ V}$ Digital inputs = 0 V or V_{DD}
I_{DD} , 8-Lead MSOP	58	95		μA max	Digital inputs = 5 V
I_{DD} , 8-Lead LFCSP	120	190		μA typ	Digital inputs = 5 V
V_{DD}		5/16.5		V min/max	Ground = 0 V, $V_{SS} = 0 \text{ V}$

¹ Guaranteed by design, not subject to production test.

±5 V DUAL SUPPLY

$V_{DD} = +5 \text{ V} \pm 10\%$, $V_{SS} = -5 \text{ V} \pm 10\%$, GND = 0 V, unless otherwise noted.

Table 3.

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$V_{DD} \text{ to } V_{SS}$	V	
On Resistance, R_{ON}	4.5			Ω typ	$V_S = \pm 4.5 \text{ V}, I_S = -10 \text{ mA}$; see Figure 22
On Resistance Match Between Channels, ΔR_{ON}	5.2	6.2	7	Ω max	$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}$
On Resistance Flatness, $R_{FLAT(ON)}$	0.1			Ω typ	$V_S = \pm 4.5 \text{ V}, I_S = -10 \text{ mA}$
	0.3	0.35	0.4	Ω max	
	1.3			Ω typ	$V_S = \pm 4.5 \text{ V}, I_S = -10 \text{ mA}$
	1.6	1.85	2	Ω max	
LEAKAGE CURRENTS					
Source Off Leakage, I_S (Off)	±0.1			nA typ	$V_{DD} = +5.5 \text{ V}, V_{SS} = -5.5 \text{ V}$
	±0.5	±2	±75	nA max	$V_S = \pm 4.5 \text{ V}, V_D = \mp 4.5 \text{ V}$; see Figure 23
Drain Off Leakage, I_D (Off)	±0.1			nA typ	$V_S = \pm 4.5 \text{ V}, V_D = \mp 4.5 \text{ V}$; see Figure 23
	±0.6	±3	±100	nA max	
Channel On Leakage, I_D, I_S (On)	±0.1			nA typ	$V_S = V_D = \pm 4.5 \text{ V}$; see Figure 24
	±1	±3	±100	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.001		±0.1	μA typ	
Digital Input Capacitance, C_{IN}	4			μA max	$V_{IN} = V_{GND}$ or V_{DD}
				pF typ	

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
DYNAMIC CHARACTERISTICS ¹					
Transition Time, $t_{\text{TRANSITION}}$	310			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
$t_{\text{ON}} (\text{EN})$	410	495	560	ns max	$V_S = 3 \text{ V}$; see Figure 25
$t_{\text{OFF}} (\text{EN})$	230			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
	305	355	390	ns max	$V_S = 3 \text{ V}$; see Figure 27
$t_{\text{OFF}} (\text{EN})$	220			ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
Break-Before-Make Time Delay, t_D	290	335	365	ns max	$V_S = 3 \text{ V}$; see Figure 27
	65		31	ns typ	$R_L = 300 \Omega, C_L = 35 \text{ pF}$
Charge Injection	59			pC typ	$V_{S1} = V_{S2} = 3 \text{ V}$; see Figure 26
Off Isolation	-60			dB typ	$R_L = 50 \Omega, C_L = 1 \text{ nF}, f = 1 \text{ MHz}$; see Figure 29
Channel-to-Channel Crosstalk	-60			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 30
Total Harmonic Distortion + Noise	0.04			% typ	$R_L = 10 \text{ k}\Omega, 5 \text{ V p-p}, f = 20 \text{ Hz to } 20 \text{ kHz}$; see Figure 32
-3 dB Bandwidth	105			MHz typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}$; see Figure 31
Insertion Loss	0.28			dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$; see Figure 31
$C_S (\text{Off})$	26			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
$C_D (\text{Off})$	62			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
$C_D, C_S (\text{On})$	128			pF typ	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$
POWER REQUIREMENTS					
I_{DD}	0.001			$\mu\text{A typ}$	$V_{DD} = +5.5 \text{ V}, V_{SS} = -5.5 \text{ V}$
		1.0		$\mu\text{A max}$	Digital inputs = 0 V or V_{DD}
I_{SS}	0.001			$\mu\text{A typ}$	$V_{DD} = 0 \text{ V}$
		1.0		$\mu\text{A max}$	Digital inputs = 0 V or V_{DD}
V_{DD}/V_{SS}		$\pm 4.5/\pm 16.5$		$V_{\text{min/max}}$	Ground = 0 V

¹ Guaranteed by design, not subject to production test.

CONTINUOUS CURRENT PER CHANNEL, S OR D

Table 4.

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL ¹					
+15 V Dual Supply					
8-Lead MSOP ($\theta_{JA} = 206^\circ\text{C/W}$)	215	135	80	mA maximum	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}$
8-Lead LFCSP ($\theta_{JA} = 50.8^\circ\text{C/W}$)	390	215	100	mA maximum	
+12 V Single Supply					
8-Lead MSOP ($\theta_{JA} = 206^\circ\text{C/W}$)	175	115	70	mA maximum	$V_{DD} = 10.8 \text{ V}, V_{SS} = 0 \text{ V}$
8-Lead LFCSP ($\theta_{JA} = 50.8^\circ\text{C/W}$)	320	185	95	mA maximum	
±5 V Dual Supply					
8-Lead MSOP ($\theta_{JA} = 206^\circ\text{C/W}$)	165	110	70	mA maximum	$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}$
8-Lead LFCSP ($\theta_{JA} = 50.8^\circ\text{C/W}$)	310	180	95	mA maximum	

¹ Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 5.

Parameter	Rating
V _{DD} to V _{SS}	35 V
V _{DD} to GND	-0.3 V to +25 V
V _{SS} to GND	+0.3 V to -25 V
Analog Inputs ¹	V _{SS} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	GND – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D (Pulsed at 1 ms, 10% Duty-Cycle Maximum)	
8-Lead MSOP (4-Layer Board)	400 mA
8-Lead LFCSP	600 mA
Continuous Current per Channel, S or D	Data in Table 4 + 15% mA
Operating Temperature Range Industrial	-40°C to +125°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature	150°C
Reflow Soldering Peak Temperature, Pb Free	260°C

¹ Over voltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 6. Thermal Resistance

Package Type	θ _{JA}	θ _{JC}	Unit
8-Lead MSOP (4-Layer Board)	206	44	°C/W
8-Lead LFCSP	50.8		°C/W

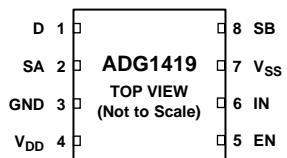
ESD CAUTION



ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

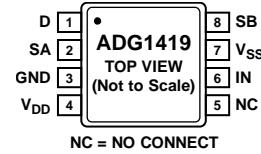


NOTES

1. EXPOSED PAD TIED TO SUBSTRATE, V_{SS}.

08485-003

Figure 3. 8-Lead LFCSP Pin Configuration



NC = NO CONNECT

08485-004

Figure 4. 8-Lead MSOP Pin Configuration

Table 7. 8-Lead LFCSP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	D	Drain Terminal. This pin can be an input or output.
2	SA	Source Terminal. This pin can be an input or output.
3	GND	Ground (0 V) Reference.
4	V _{DD}	Most Positive Power Supply Potential.
5	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are turned off. When this pin is high, the IN logic input determines which switch is turned on.
6	IN	Logic Control Input.
7	V _{SS}	Most Negative Power Supply Potential.
8	SB	Source Terminal. This pin can be an input or output.
	EPAD	Exposed pad tied to substrate, V _{SS} .

Table 9. 8-Lead MSOP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	D	Drain Terminal. This pin can be an input or output.
2	SA	Source Terminal. This pin can be an input or output.
3	GND	Ground (0 V) Reference.
4	V _{DD}	Most Positive Power Supply Potential.
5	NC	No Connect.
6	IN	Logic Control Input.
7	V _{SS}	Most Negative Power Supply Potential.
8	SB	Source Terminal. This pin can be an input or output.

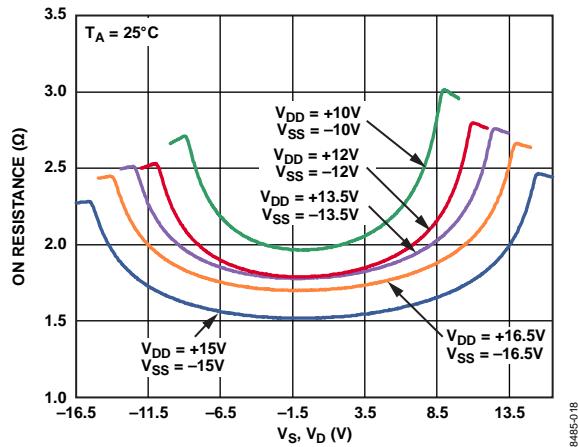
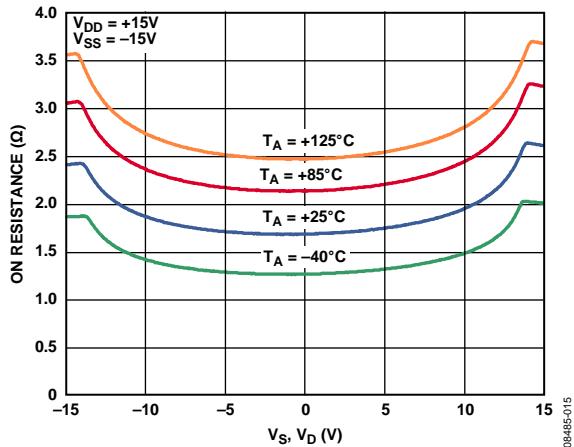
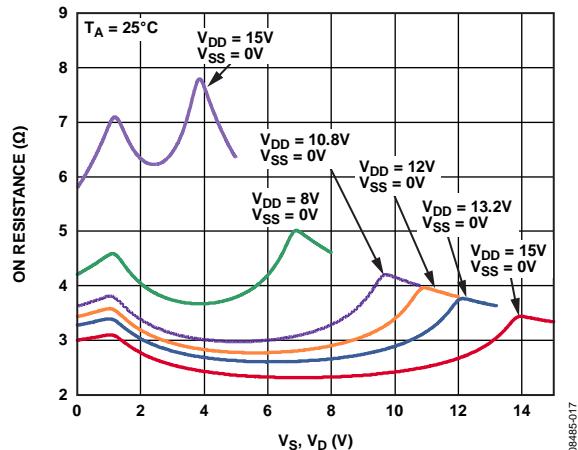
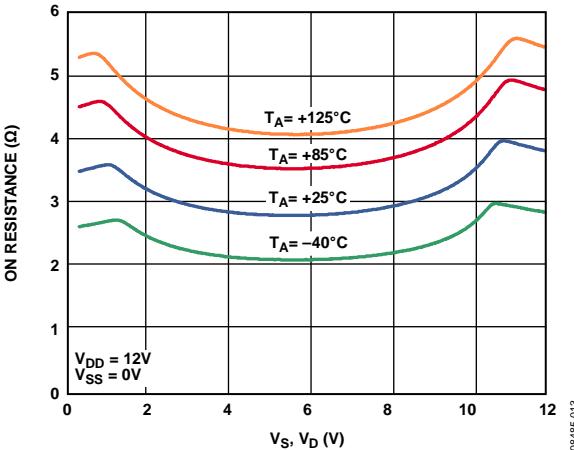
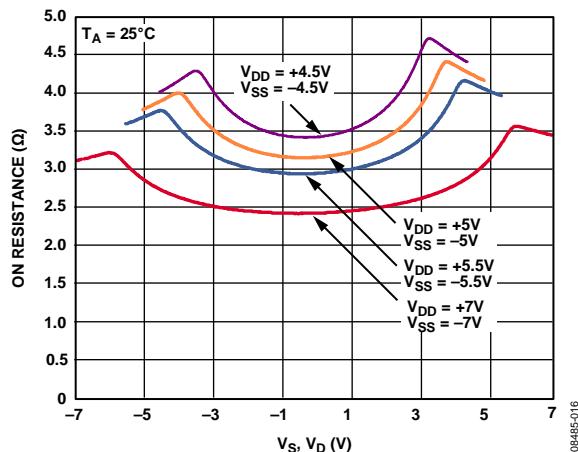
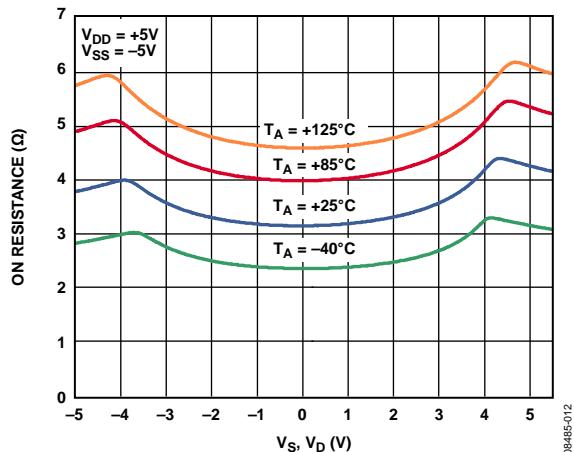
Table 10. 8-Lead MSOP Truth Table

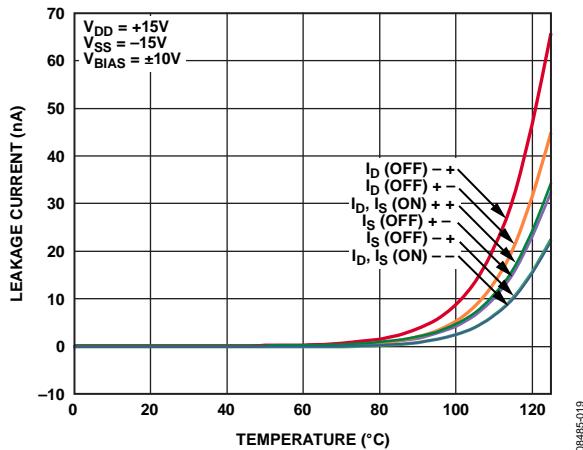
IN	Switch A	Switch B
0	On	Off
1	Off	On

Table 8. 8-Lead LFCSP Truth Table

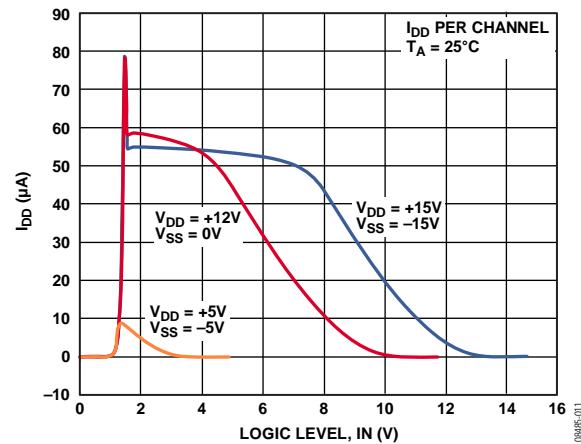
EN	IN	Switch A	Switch B
0	X	Off	Off
1	0	On	Off
1	1	Off	On

TYPICAL PERFORMANCE CHARACTERISTICS

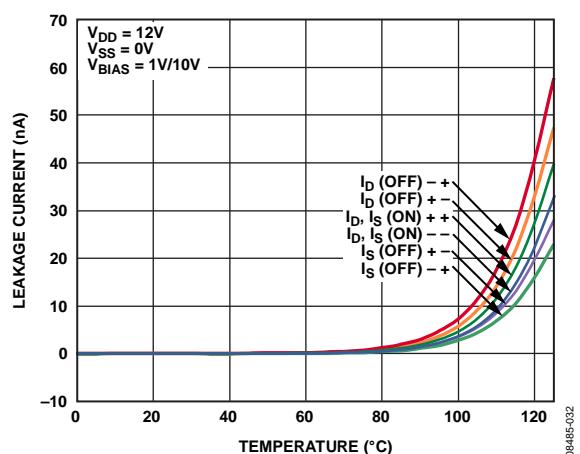
Figure 5. On Resistance as a Function of V_D (V_S) for Dual SupplyFigure 8. On Resistance as a Function of V_D (V_S) for Different Temperatures, ± 15 V Dual SupplyFigure 6. On Resistance as a Function of V_D (V_S) for Single SupplyFigure 9. On Resistance as a Function of V_D (V_S) for Different Temperatures, +12 V Single SupplyFigure 7. On Resistance as a Function of V_D (V_S) for Dual SupplyFigure 10. On Resistance as a Function of V_D (V_S) for Different Temperatures, ± 5 V Dual Supply



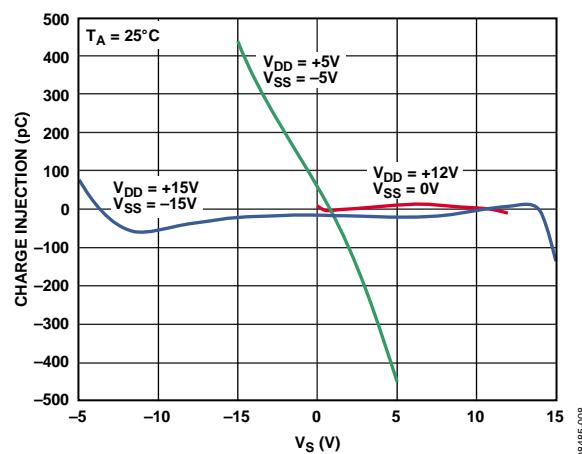
08485-019



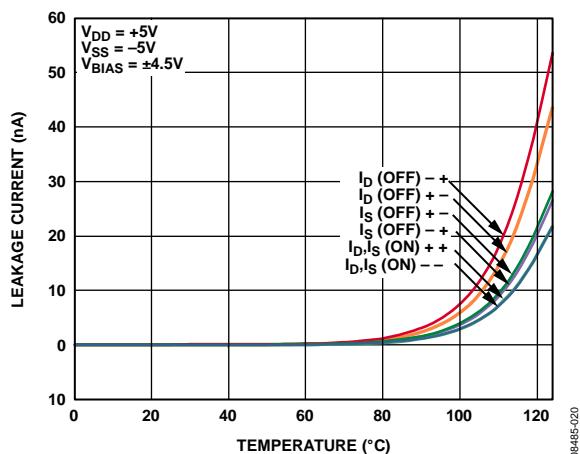
08485-011



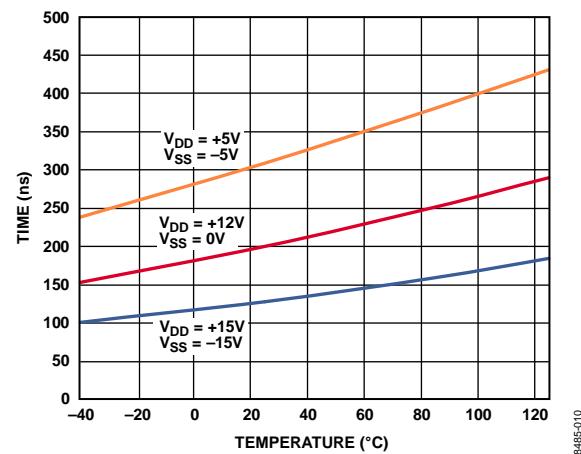
08485-032



08485-008



08485-020



08485-010

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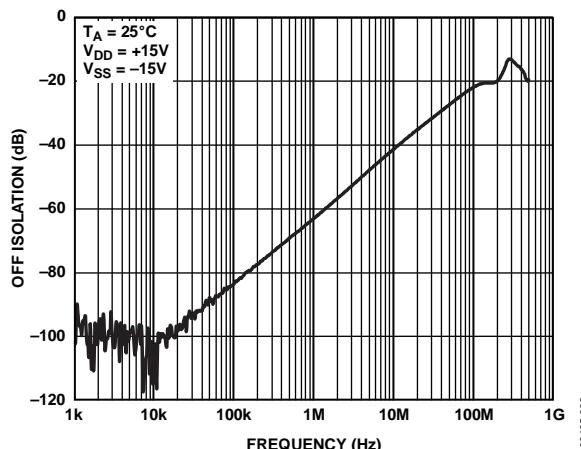


Figure 17. Off Isolation vs. Frequency

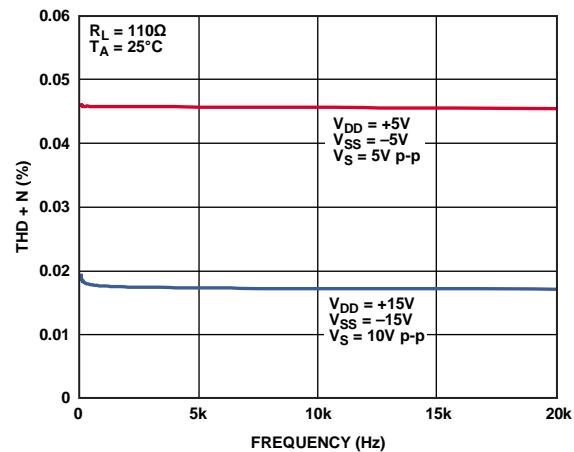


Figure 20. THD + N vs. Frequency

08485-009

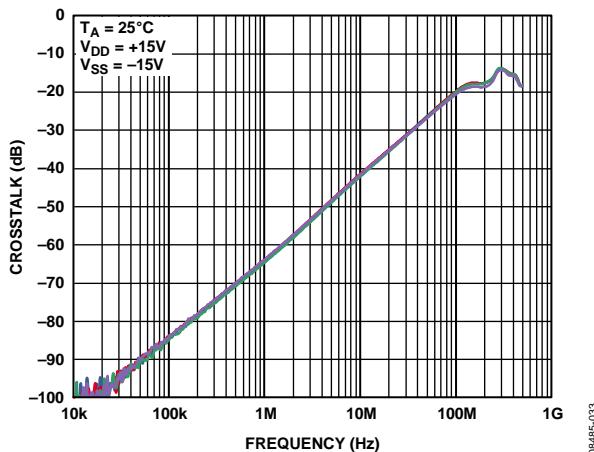


Figure 18. Crosstalk vs. Frequency

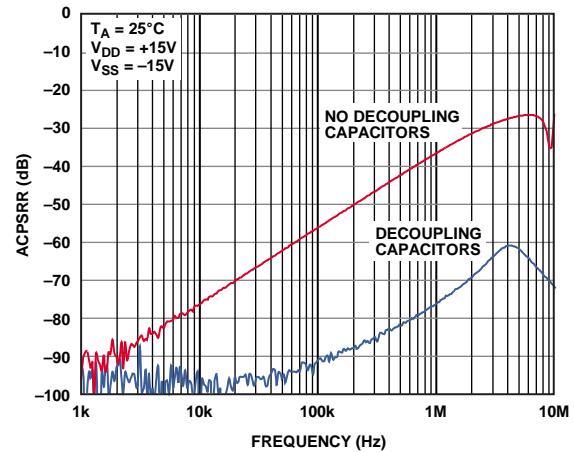


Figure 21. ACPSRR vs. Frequency

08485-007

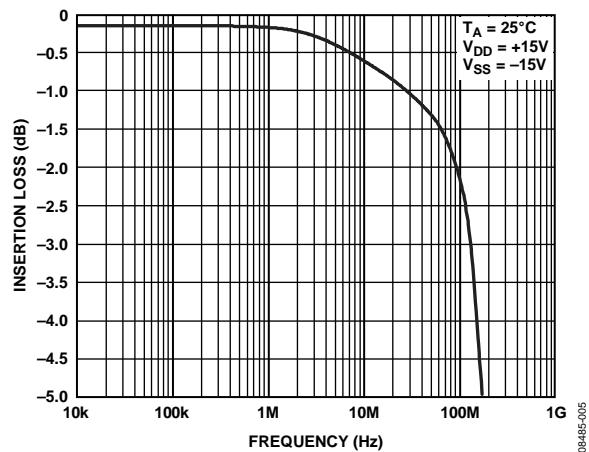
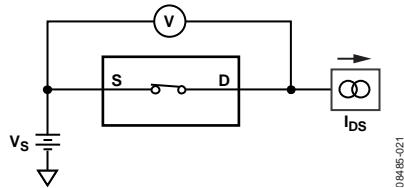
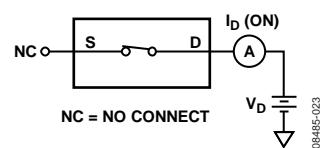


Figure 19. On Response vs. Frequency

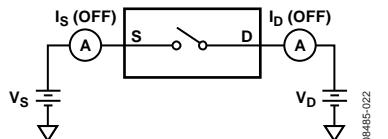
TEST CIRCUITS



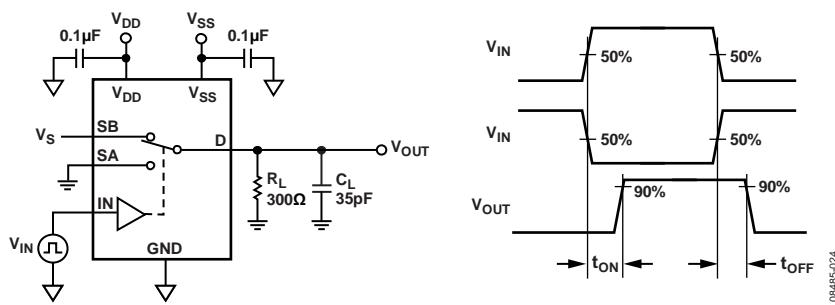
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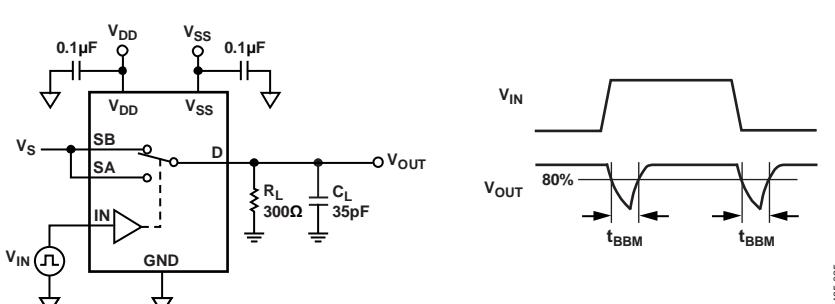
08485-023



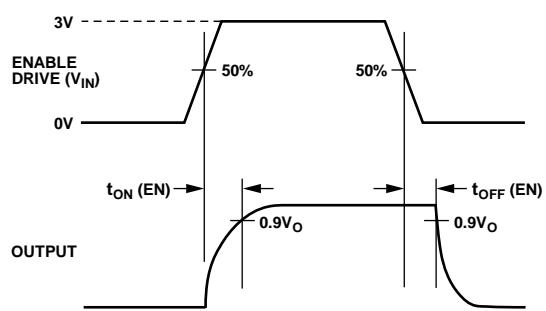
08485-022



08485-024



08485-025



08485-026

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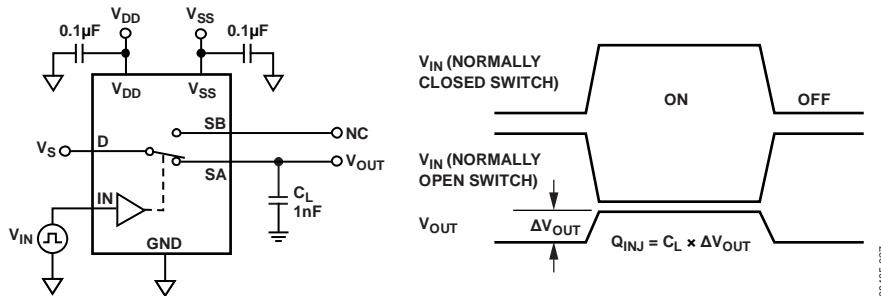


Figure 28. Charge Injection

08485-027

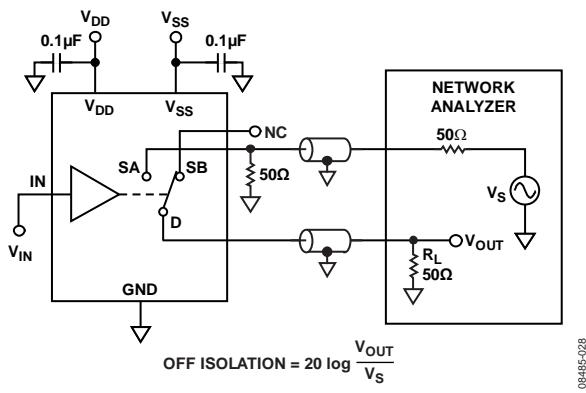


Figure 29. Off Isolation

08485-028

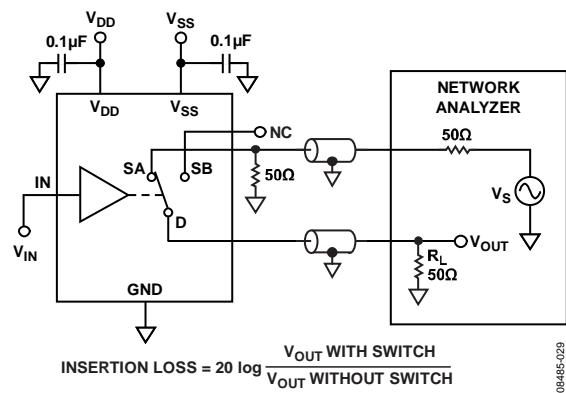


Figure 31. Bandwidth

08485-029

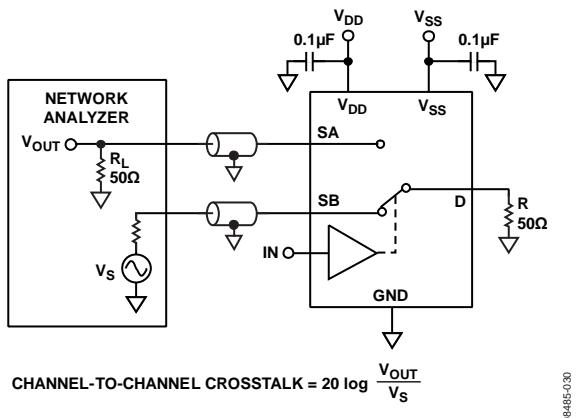


Figure 30. Channel-to-Channel Crosstalk

08485-030

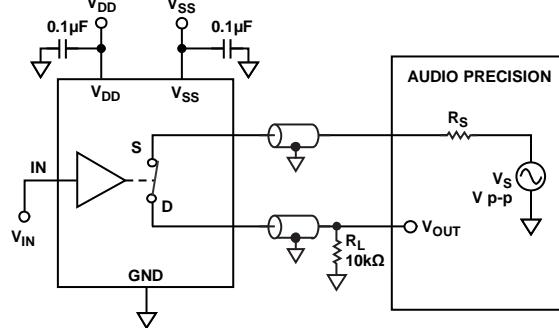


Figure 32. THD + N

08485-031

TERMINOLOGY

I_{DD}

The positive supply current.

I_{SS}

The negative supply current.

V_D (V_S)

The analog voltage on Terminal D and Terminal S.

R_{ON}

The ohmic resistance between Terminal D and Terminal S.

R_{FLAT (ON)}

Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.

I_{S (Off)}

The source leakage current with the switch off.

I_{D (Off)}

The drain leakage current with the switch off.

I_{D, I_{S (On)}}

The channel leakage current with the switch on.

V_{INL}

The maximum input voltage for Logic 0.

V_{INH}

The minimum input voltage for Logic 1.

I_{INL (I_{INH})}

The input current of the digital input.

C_{S (Off)}

The off switch source capacitance, measured with reference to ground.

C_{D (Off)}

The off switch drain capacitance, measured with reference to ground.

C_{D, C_{S (On)}}

The on switch capacitance, measured with reference to ground.

C_{IN}

The digital input capacitance.

t_{ON (EN)}

Delay time between the 50% and 90% points of the digital input and switch on condition. See Figure 27.

t_{OFF (EN)}

Delay time between the 50% and 90% points of the digital input and switch off condition. See Figure 27.

t_{TRANSITION}

Delay time between the 50% and 90% points of the digital inputs and the switch on condition when switching from one address state to another.

T_{BBM}

Off time measured between the 80% point of both switches when switching from one address state to another. See Figure 26.

Charge Injection

A measure of the glitch impulse transferred from the digital input to the analog output during switching. See Figure 28.

Off Isolation

A measure of unwanted signal coupling through an off switch. See Figure 29.

Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance. See Figure 30.

Bandwidth

The frequency at which the output is attenuated by 3 dB. See Figure 31.

On Response

The frequency response of the on switch.

Insertion Loss

The loss due to the on resistance of the switch. See Figure 31.

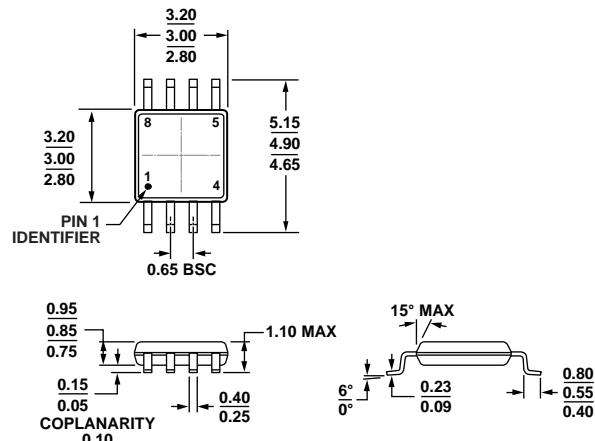
THD + N

The ratio of the harmonic amplitude plus noise of the signal to the fundamental. See Figure 32.

AC Power Supply Rejection Ratio (ACPSRR)

ACPSRR measures the ability of a part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p. The ratio of the amplitude of signal on the output to the amplitude of the modulation is the ACPSRR. See Figure 21.

OUTLINE DIMENSIONS

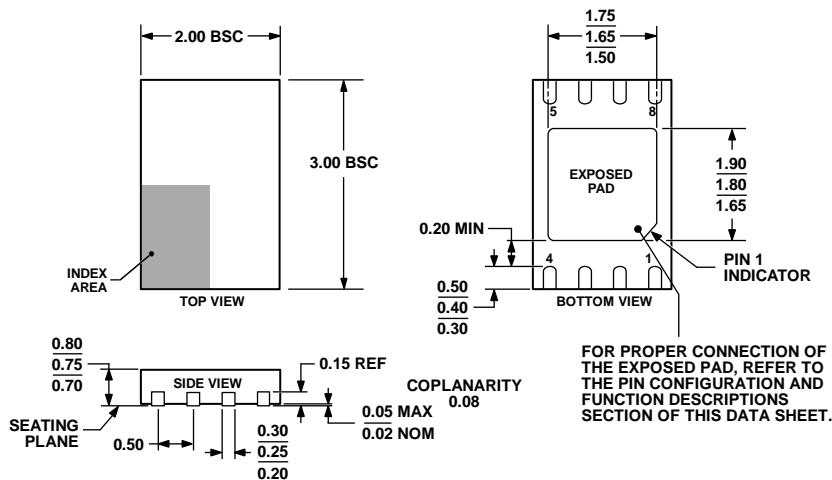


COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 33. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)

Dimensions shown in millimeters

10078-B



081806-A

Figure 34. 8-Lead Lead Frame Chip Scale Package [LFCSP_WD]
3 mm × 2 mm Body, Very Very Thin, Dual Lead
(CP-8-4)

Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
ADG1419BRMZ ¹	-40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1L
ADG1419BRMZ-REEL7 ¹	-40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1L
ADG1419BCPZ-REEL7 ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package [LFCSP_WD]	CP-8-4	1C

¹ Z = RoHS Compliant Part.

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NOTES